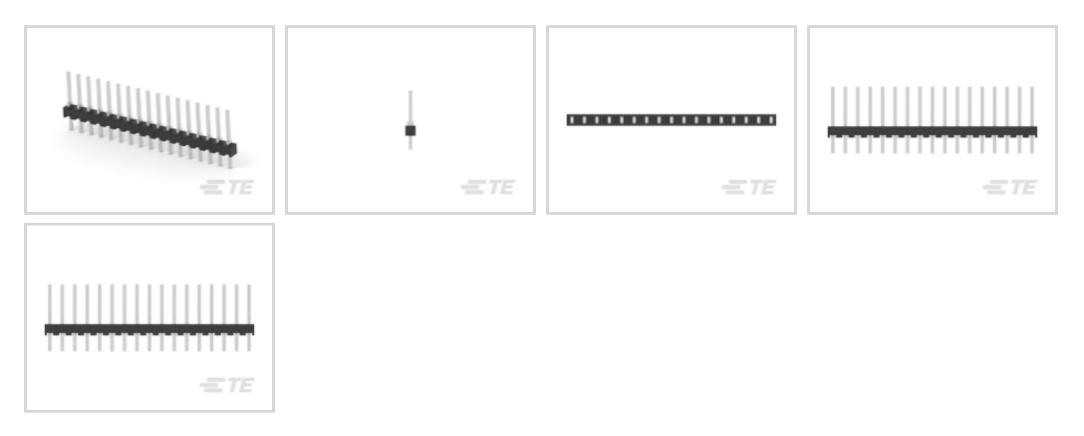
1-87348-7 - ACTIVE

TE Internal #: 1-87348-7 PCB Mount Header, Vertical, Board-to-Board, 17 Position, 2.54 mm [.1 in] Centerline, Unshrouded, Tin-Lead, Through Hole - Solder, Signal, Black

### View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 17

Number of Rows: 1

# Features

Product Type Features



PCB Connector Assembly Type	PCB Mount Header	
Connector System	Board-to-Board	
Header Type	Unshrouded	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
Configuration Features		
Connector Contact Load Condition	Fully Loaded	
PCB Mount Orientation	Vertical	
PCB Mount Orientation Number of Positions	Vertical 17	
Number of Positions	17	
Number of Positions Number of Rows	17	
Number of Positions Number of Rows Board-to-Board Configuration	17	

PCB Mount Header, Vertical, Board-to-Board, 17 Position, 2.54 mm [.1 in] Centerline, Unshrouded, Tin-Lead, Through Hole - Solder, Signal, Black



# **Body Features**

Primary Product Color	Black
Contact Features	
Contact Shape & Form	Square
Contact Mating Area Plating Material Finish	Bright
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Tin-Lead
Contact Mating Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Termination Post & Tail Length	3.18 mm[.125 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Nylon-GF
Dimensions	
PCB Thickness (Recommended)	1.57 mm[.062 in]
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	

PCB Mount Header, Vertical, Board-to-Board, 17 Position, 2.54 mm [.1 in] Centerline, Unshrouded, Tin-Lead, Through Hole - Solder, Signal, Black



UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Type	Carton
<b>Product Compliance</b> For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) SVHC > Threshold: Pb (13% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.
Solder Process Capability	Not reviewed for solder process capability

### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**

PCB Mount Header, Vertical, Board-to-Board, 17 Position, 2.54 mm [.1 in] Centerline, Unshrouded, Tin-Lead, Through Hole - Solder, Signal, Black



TE Part # 1-5535677-7 17 MODII HORZ SR CE 100CL

# Customers Also Bought



CRGS2512	5%	1M8	
CINUSZUIZ	570		

PT570N20

# Documents

Product Drawings

17 MODII HDR SRST UNSHRD .100

English

**CAD** Files

3D PDF

3D

Customer View Model ENG\_CVM\_CVM\_1-87348-7\_L.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_1-87348-7\_L.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_1-87348-7\_L.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

**S** For support call+1 800 522 6752

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PCB Mount Header, Vertical, Board-to-Board, 17 Position, 2.54 mm [.1 in] Centerline, Unshrouded, Tin-Lead, Through Hole - Solder, Signal, Black



Agency Approvals UL

English